

B<sup>25</sup> the [wire] stem has a diameter between 0.0007 and 0.003 inches; and  
the nickel has a thickness between 0.00010 and 0.003 inches.

[ Cancel claims 244-266, without prejudice.

B<sup>26</sup> <sup>41</sup>  
267. (AMENDED) Method, according to claim [266] ~~15~~, wherein:  
[the] a plurality of [wire] stems are arranged in an array pattern on [the] a surface of the electronic component.

[ Cancel claims 268-277, without prejudice.

IN THE SPECIFICATION:

At the top of page 1, change the title of the invention from  
"MANUFACTURING RAISED ELECTRICAL CONTACTS HAVING CONTROLLED  
GEOMETRY" to -- METHOD OF MANUFACTURING ELECTRICAL CONTACTS, USING  
A SACRIFICIAL MEMBER --